



JT58SBC Transient Voltage Suppressor

Rev.4.2

DESCRIPTION:

JT58SBC is designed for DC 48V, POE supply equipment, It is used to replace the SMDJ series TVS, also can be solve the POE normal solution which use TSPD.

FEATURES:

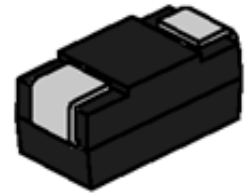
- ✧ Low profile package.
- ✧ Excellent clamping capability.
- ✧ Glass passivated junction.
- ✧ High temperature reflow soldering: 260°C/40s at terminals.
- ✧ Plastic package has underwriters laboratory flammability 94V-0.
- ✧ Meets MSL level 1, per J-STD-020, LF maximum peak of 260°C.
- ✧ Terminal: solder plated, solderable per J-STD-002.
- ✧ For surface mounted applications in order to optimize board space.
- ✧ UL 1449 item recognized. (File No.: E494389).
- ✧ IEC61000-4-2 (ESD) ±30kV (air), ±30kV (contact).

SURGE LEVEL:

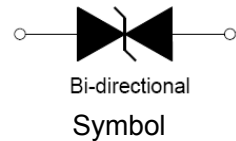
- ✧ 10/700µs 40ohm 4KV
- ✧ 1.2/50µs-8/20µs 2ohm 1KV

ABSOLUTE MAXIMUM RATINGS (T_A=25°C, RH=45%-75%, unless otherwise noted)

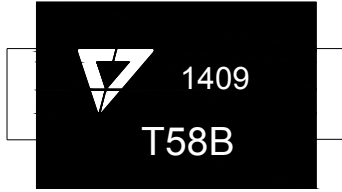
Parameter	Symbol	Value	Unit
Storage operating junction temperature range	T _{STG} /T _J	-55 to +150	°C
Steady state power dissipation at T _L =75°C	P _{M(AV)}	5.0	W
Peak pulse power (t _P =10/1000µs)	P _{PP}	2000	W
Peak surge voltage at 10/700µs waveform	V _{PP}	4000	V
Peak pulse current at 8/20µs waveform	I _{PP}	500	A
Peak pulse current at 10/1000µs waveform	I _{PP}	24.0	A



SMB



MARKING



T58B: Device Marking Code
1409: In ninth week, 2014

ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$)

Part Number	V_R	$I_R@V_R$	$V_{BR}@I_T$		I_T	$V_C@10/700\mu\text{s}$	$V_C@8/20\mu\text{s}$	$V_C@$
			4KV /40Ω	500A		10/1000μs		
Bi-polar	V	max(μA)	min(V)	max(V)	mA	max(V)	max(V)	max(V)
JT58SBC	58	1	60	72	1	85	85	85

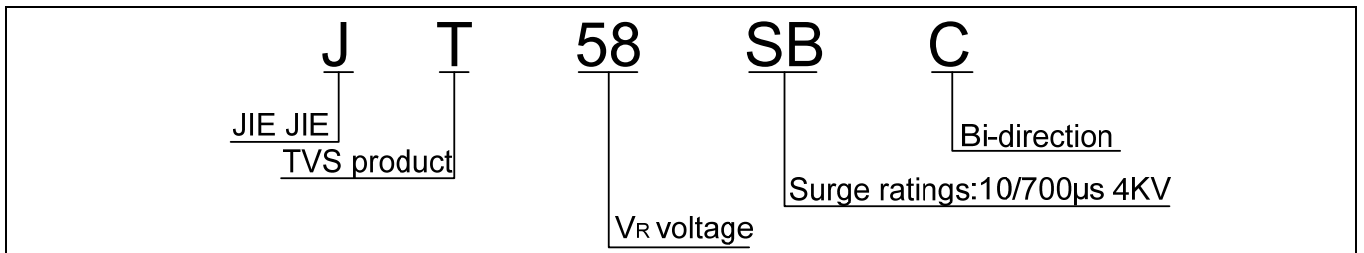
V_R : Stand-off voltage -- Maximum voltage that can be applied

V_{BR} : Breakdown voltage

V_C : Clamping voltage -- Peak voltage measured across the suppressor at a specified surge voltage

I_R : Reverse leakage current

ORDERING INFORMATION



RATINGS AND V-I CHARACTERISTICS CURVES ($T_A=25^\circ\text{C}$, unless otherwise noted)

FIG.1: V- I curve characteristics (Bi-directional with negative resistance)

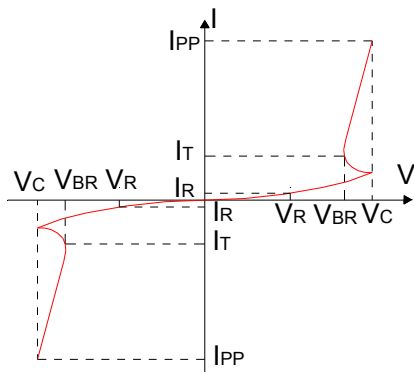


FIG.2: Pulse waveform

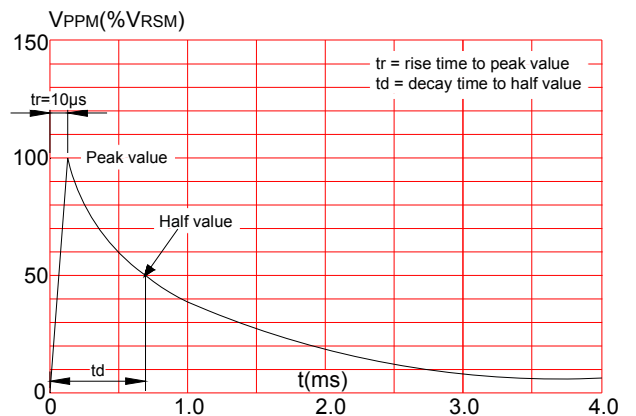


FIG.3: Pulse waveform

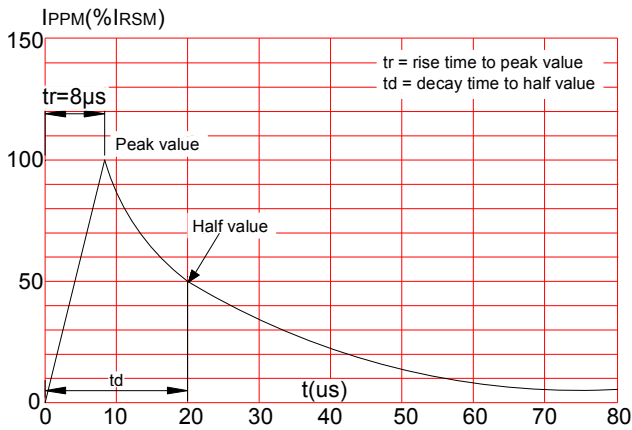


FIG.4: Pulse waveform

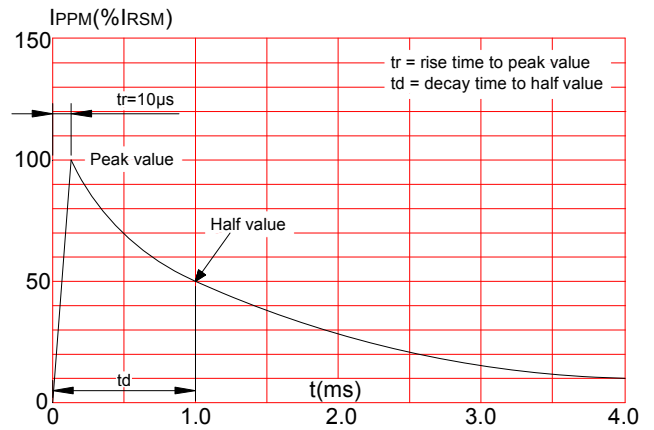
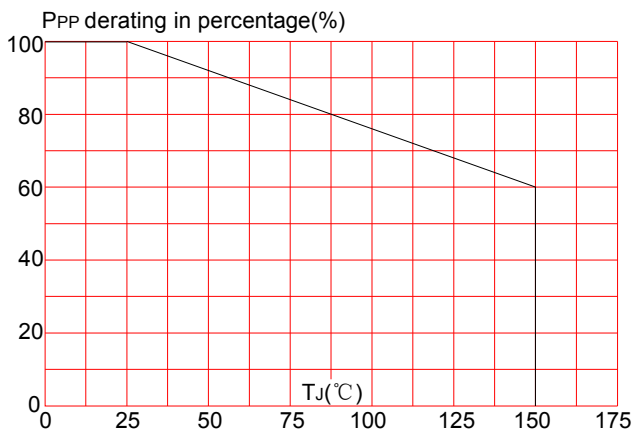
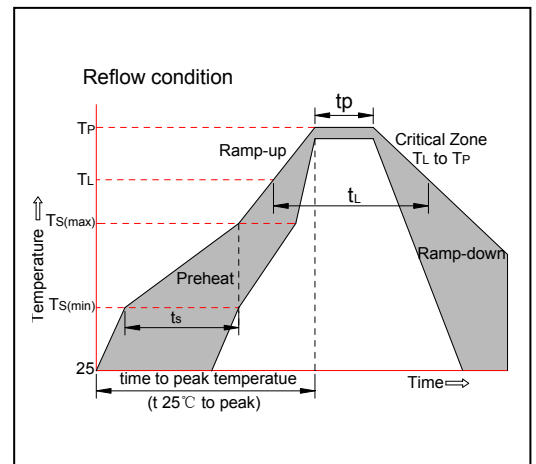


FIG.5: Pulse derating curve(10/1000μs)

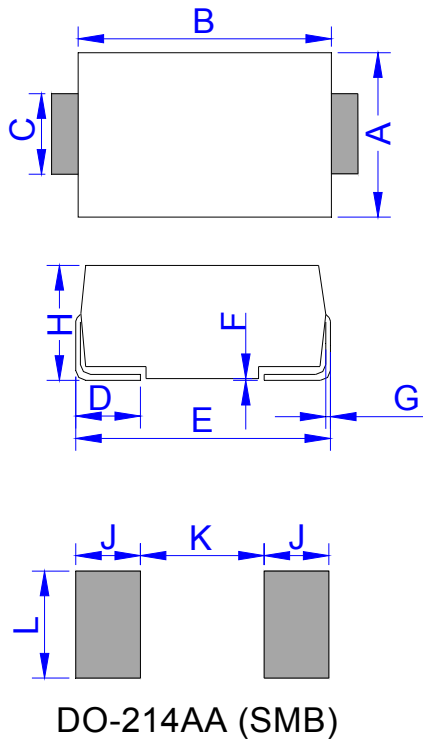


SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see figure at right)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L)(Liquidus)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		20-40secs.
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_p)		8 min. Max
Do not exceed		+260°C

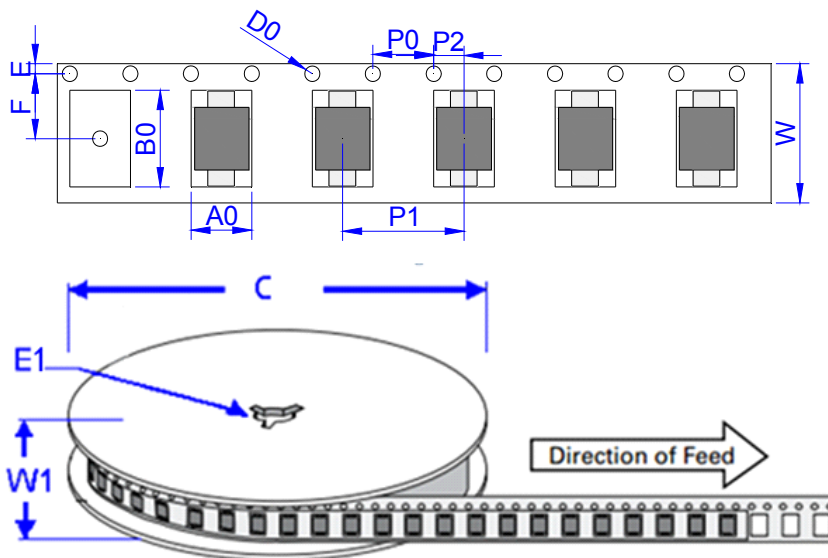


PACKAGE MECHANICAL DATA



Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	3.30	3.94	0.130	0.155
B	4.30	4.80	0.169	0.189
C	1.90	2.20	0.075	0.087
D	0.95	1.52	0.037	0.060
E	5.20	5.60	0.205	0.220
F	0.051	0.203	0.002	0.008
G	0.15	0.31	0.006	0.012
H	2.10	2.40	0.083	0.094
J	2.20		0.087	
K		2.60		0.102
L	2.30		0.091	

TAPE AND REEL SPECIFICATION-SMB



Ref.	Dimensions	
	Millimeters	Inches
A0	3.76 ± 0.3	0.148 ± 0.012
B0	5.69 ± 0.3	0.224 ± 0.012
C	330.0	13.0
D0	1.55 ± 0.1	0.061 ± 0.004
E	1.75 ± 0.2	0.069 ± 0.008
E1	13.3 ± 0.3	0.524 ± 0.012
F	5.5 ± 0.2	0.217 ± 0.008
P0	4.00 ± 0.2	0.157 ± 0.008
P1	8.00 ± 0.2	0.3145 ± 0.008
P2	2.00 ± 0.2	0.079 ± 0.008
W	12.0 ± 0.2	0.472 ± 0.008
W1	15.7 ± 2.0	0.618 ± 0.079

PART No.	UNIT WEIGHT (g/PCS) typ.	REEL (PCS)	PER CARTON (PCS)	DESCRIPTION
JT58SBC	0.106	3,000	48,000	13 inch reel pack

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